H. H. HARRIS FOUNDATION

SCHOLARSHIP APPLICATIONS

The H. H. Harris Foundation was created for the purpose of providing scholarships and other forms of educational aid to students and professionals in the metallurgical and casting of metals field who are U.S. Citizens.

The average grant last year was in excess of $1,000 per student.

Application for scholarships with two letters of reference is due as soon as possible and must be received no later than May 31, 2013.

Write for an application to:

H. H. Harris Foundation
Attn: Charles L. Michod, Jr., Trustee
333 West Wacker Drive
Suite 2000
Chicago, Illinois 60606-1288
FAX: (312) 236-6706
Email: cmichod@komdr.com
H. H. Harris Scholarship Applications

In order to facilitate the compiling of applications, the applicants are advised of the following:

1. The two required reference letters should start as follows:
   
   “I am seconding John Doe, who is attending (will be attending) XYZ University.”

2. All applications should be signed. We will not accept any unsigned applications or those that do not have two (2) reference letters.

3. All parts of the application form are important for the Foundation Members’ consideration and should be completed with care.

4. The deadline for the 2013 applications is May 31, 2013.

Sincerely yours,

H.H. HARRIS FOUNDATION

By: Charles L. Michod, Jr., Trustee

CLM, JR:
Encl.
The H.H. Harris Foundation was established pursuant to the terms of the Last Will of Henry Hickman Harris for the purpose of providing scholarships and other forms of educational aid to students and professionals in the metallurgical and casting of metals field who are U.S. citizens.

The Foundation members meet annually to make awards during June.

Applicants for scholarships should be submitted on this form along with two letters of reference to:

H.H. Harris Foundation
Attn: Charles L. Michod, Jr., Trustee
333 West Wacker Drive
Suite 2000
Chicago, Illinois 60606-1288

The deadline for 2013 is May 31, 2013.
SCHOLARSHIP APPLICATION

(PLEASE TYPE OR PRINT IN BLACK INK)

1. **Personal Information:**
   Name ________________________________
   Address ________________________________
   City ___________________ State _______ Zip _______
   Age _____ Marital Status _______ U.S. Citizen: Yes □ No □ (You must be a U.S. Citizen to qualify)
   Phone Number ___________________________ Email ___________________________
   Number of dependents you support including yourself ___________________________
   Social Security Number ___________________________

2. **Educational Background:**
   High School ___________________________________________________________
   Location _____________________________________________________________
   Date of Graduation ____________________________
   Grade Point Average ___________________________ out of possible _____________
   Undergraduate School _________________________________________________
   Location _____________________________________________________________
   Major ____________________________
   Current School Class _________________________________________________
   Grade Point Average ___________________________ out of possible _____________
   Date you expect to graduate ___________________________________________
   School you expect to attend this coming year _____________________________
   Graduate School (If Applicable) _________________________________________
   Location _____________________________________________________________
   Concentration _________________________________________________________
   Grade Point Average ___________________________ out of possible _____________
   Date you expect to graduate ___________________________________________

How many children including you do your parents presently have in schools where tuition and/or room and board had been paid? _______________________________________________
3. **Financial:**
   Expenses you anticipate for the next school year $___________________________
   Estimate the dollar amount of support for the next school year available from:
   Parents $______________________________________________________________
   Spouse $_____________________________________________________________
   Employment $___________________________________________________________
   Other Scholarships and/or Aid already granted for this coming school year. Please give amount, date and name of organization that granted you the funds.
   ____________________________________________________________________
   ____________________________________________________________________
   ____________________________________________________________________
   Amount you request from the H.H. Harris Foundation for the forthcoming school year __________
   Are you claimed as a dependent on your parent(s) Federal Income tax return? Yes ☐ No ☐
   Was your parent(s) taxable income for the last year larger than $75,000? Yes ☐ No ☐

4. **Employment Experience:**
   Employer and dates of employment for the last three years:
   Employer _____________________________ Dates: From _______ To __________
   Employer _____________________________ Dates: From _______ To __________
   Employer _____________________________ Dates: From _______ To __________
   Experience in metallurgical and casting of metals fields or related industries:
   ____________________________________________________________________
   ____________________________________________________________________
   ____________________________________________________________________
   ____________________________________________________________________
   ____________________________________________________________________

5. **Statement of Purpose:**
   Briefly summarize your career plans and goals with regard to the cast metal and/or the metallurgical fields.
6. Attach or have mailed separately two original letters of reference from individuals familiar with your capabilities in the metallurgical and casting of metal field. (Candidate must sign for application to be valid)

Date ____________________________________________

Applicant ____________________________________________

NOTE: UNSIGNED APPLICATIONS WILL NOT BE CONSIDERED